



Tsi381™ PCIe® to PCI Bridge Product Brief

Features

General

- PCI Express to PCI bridge
- Transparent, Non-transparent, and Opaque modes
- Efficient queuing and buffering for low latency and high throughput
- Compliant with the following specifications:
 - PCI Express Base 1.1
 - PCI Express PCI/PCI-X Bridge 1.0
 - PCI-to-PCI Bridge Architecture 1.2
 - PCI Local Bus 3.0
 - PCI Bus Power Management Interface 1.2

PCI Express

- x1 lane PCIe Interface
- Advanced error reporting capability
- End-to-end CRC check and generation
- Up to four outstanding memory reads
- ASPM L0 link state power management
- Legacy interrupt signaling and MSI interrupts
- Hot Plug support

PCI

- 32/64-bit addressing and 32-bit data
- Operates at 25, 33, 50, and 66 MHz
- Up to eight outstanding memory reads
- 3.3V PCI I/Os, 5V tolerant
- Four external PCI masters supported through internal arbiter
- MSI generation and handling using interrupt and GPIO signals

Other Features

- Masquerade mode
- JTAG IEEE 1149.1, 1149.6 to allow testing of the PCIe Interface
- Four GPIO pins and four interrupt pins that can generate MSIs
- D0, D3 hot, D3 cold power management state support
- 1.2V core power supply
- No power sequencing constraints
- Packaging:
 - 13x13 mm, 144-pin PBGA (10x10 mm option is available; part number Tsi382)
 - Pinout and footprint compatible with PLX PEX 8111/8112
 - Industrial temperature operating range
 - RoHS-compliant package available

Device Overview

The IDT Tsi381 is a high-performance bus bridge that connects the PCI Express protocol to the PCI bus standard. The Tsi381's PCIe Interface supports a x1 lane PCIe configuration, which enables the bridge to offer exceptional throughput performance of up to 2.5 Gbps per transmit and receive direction.

The device's PCI Interface can operate up to 66 MHz. This interface offers designers extensive flexibility by supporting three types of addressing modes: transparent, opaque, and non-transparent.

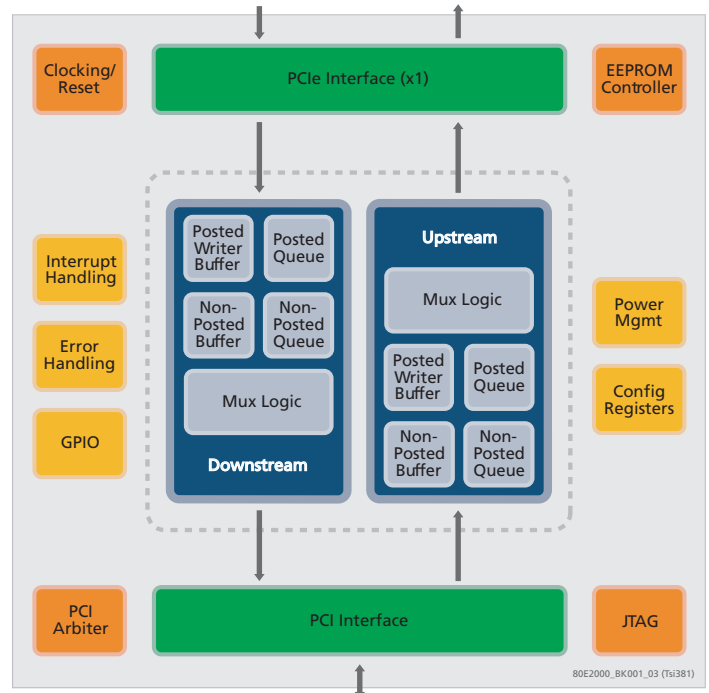


Figure 1 Block Diagram

Simplest, Low-Risk Design

The Tsi381 simplifies board design by using only two power supplies with no power sequencing constraints. Its package is designed to simplify board layout for high reliability and signal integrity. A comprehensive suite of design support resources are also available to aid designers.

Pin compatibility with the PLX PEX8111 and PEX8112 make it easy for designers to migrate current designs to the Tsi381, and thereby bring them to market quickly and with low risk.

High Performance

In addition to low-latency operation and high throughput, the Tsi381 incorporates performance enhancing features, such as short-term caching, that can provide a significant performance boost in many applications.

Transparent, Non-transparent, and Opaque Bridging

Transparent mode operation is available for efficient, flow through configurations, while non-transparent bridging allows isolation between the Tsi381's PCIe and PCI domains. Non-transparent bridging also enables multi-host systems and is used in applications such as intelligent adapter cards. Opaque mode provides semi-transparent operation for multi-processor configurations and enhanced private device support.

Typical Applications

The Tsi381 is suited to applications that need to bridge PCIe to downstream PCI devices. Its flexibility, high performance, small footprint, and low power consumption, make it ideal for a wide range of applications, including:

- Digital video recorders
- Motherboards (server, SBC, industrial PC)
- PC adapter cards (communications, graphics, imaging, and multimedia)
- Multifunction printers
- Line cards and NICs

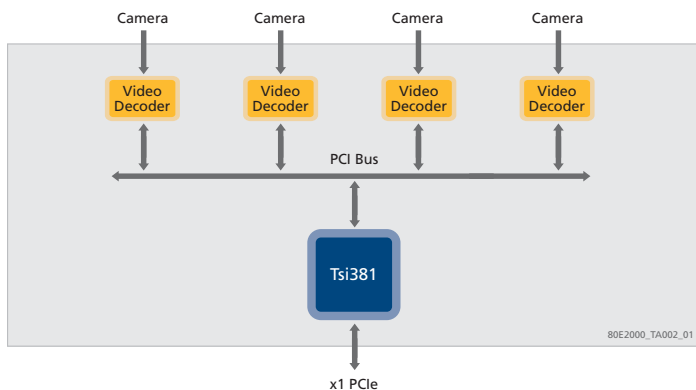


Figure 2 PC Digital Video Recorder Card Application

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CORPORATE HEADQUARTERS
6024 Silver Creek Valley Road
San Jose, CA 95138

for SALES:
800-345-7015 or 408-284-8200
fax: 408-284-2775
www.idt.com

for Tech Support:
email: ssdhelp@idt.com
phone: 408-284-8208
document: 80E2000_FB001_07

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(Rev.4.0-1 November 2017)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
Koto-ku, Tokyo 135-0061, Japan
www.renesas.com

Contact Information

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